

1/9

Fig. 1a

PRIOR ART

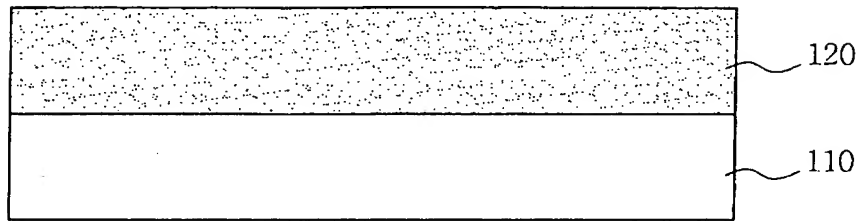
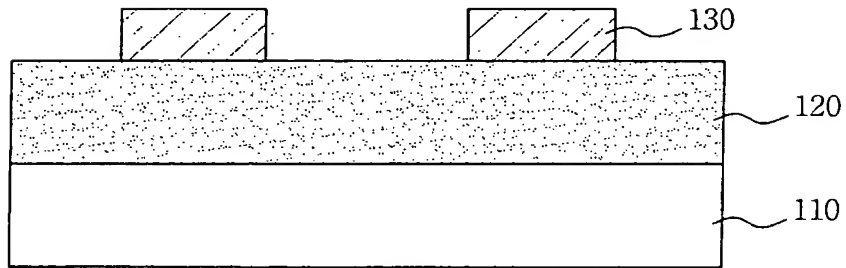


Fig. 1b

PRIOR ART



2/9

Fig. 1c

PRIOR ART

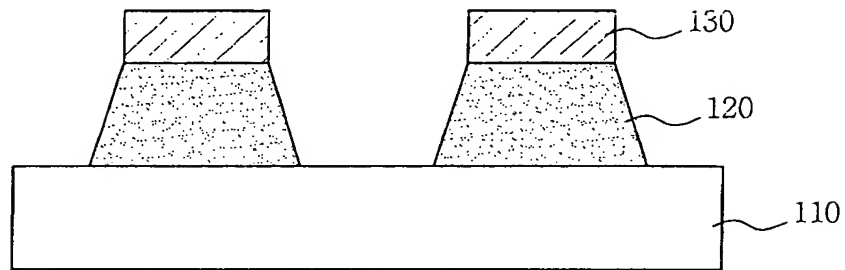
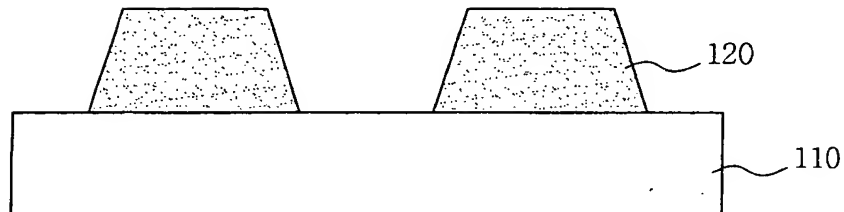


Fig. 1d

PRIOR ART



3/9

Fig. 1e

PRIOR ART

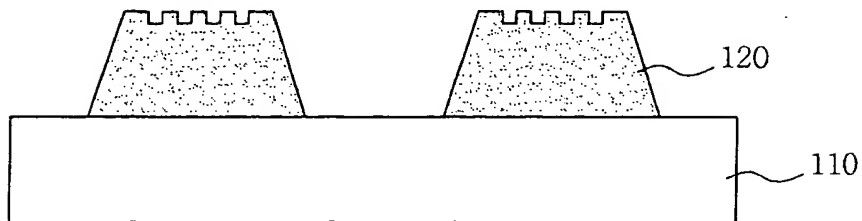


Fig. 2a

PRIOR ART

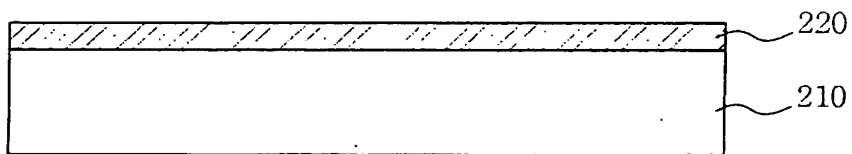
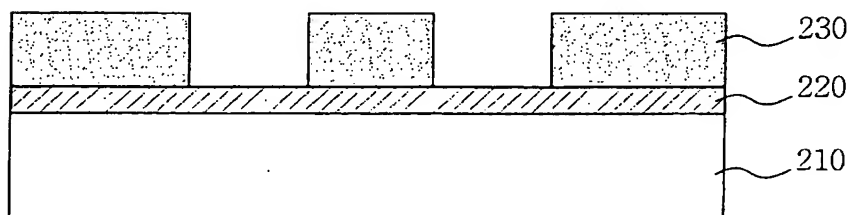


Fig. 2b

PRIOR ART



4/9

Fig. 2c

PRIOR ART

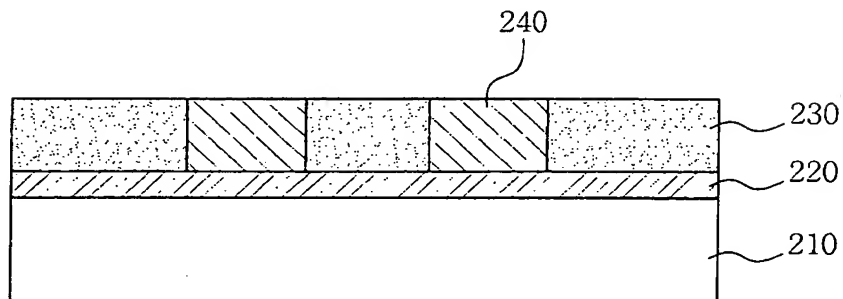
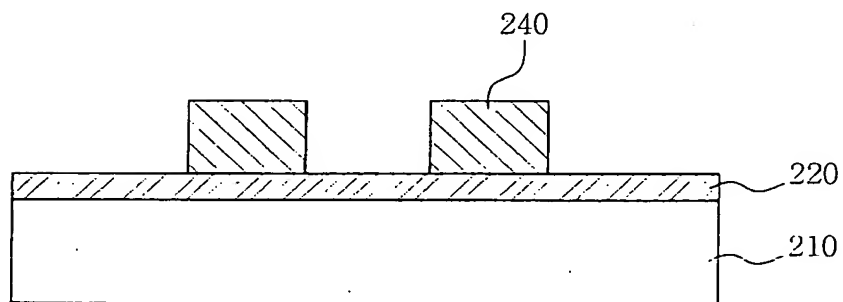


Fig. 2d

PRIOR ART



5/9

Fig. 2e

PRIOR ART

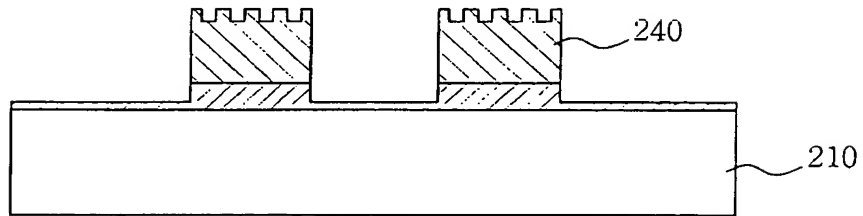


Fig. 3a

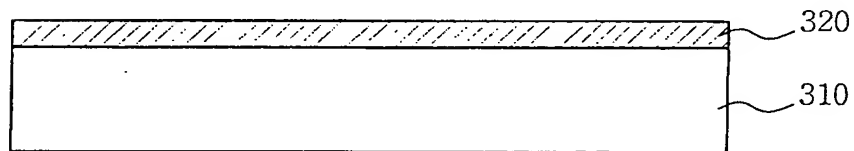
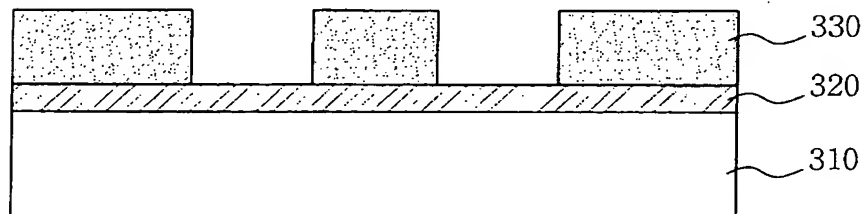


Fig. 3b



6/9

Fig. 3c

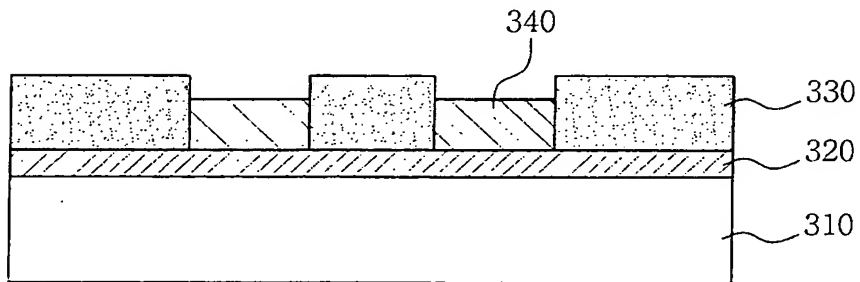


Fig. 3d

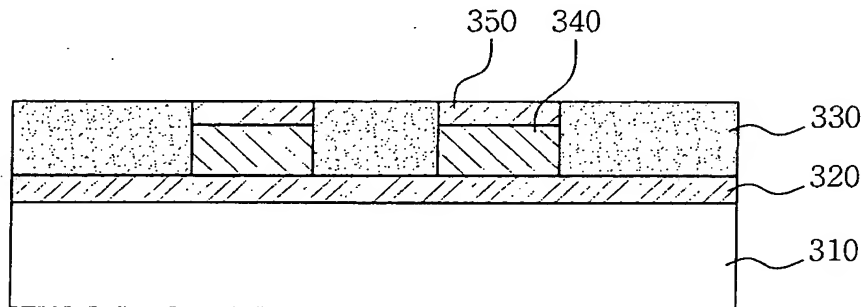
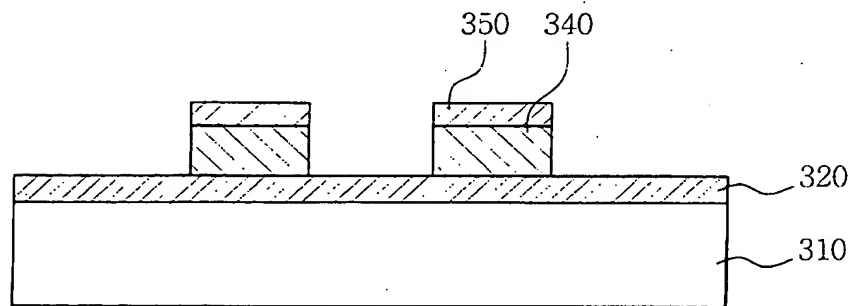


Fig. 3e



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7/9

Fig. 3f

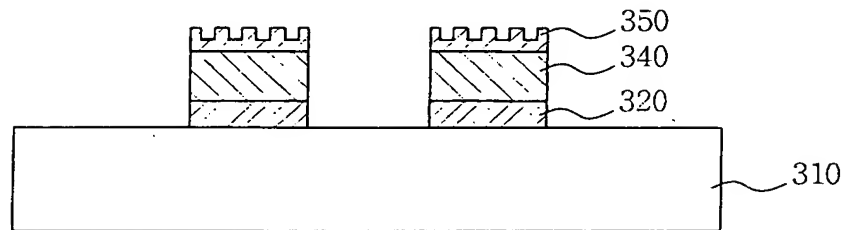
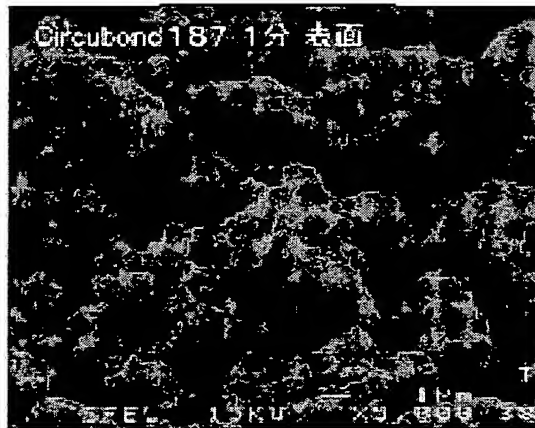


Fig. 4a

PRIOR ART



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8/9

Fig. 4b

PRIOR ART

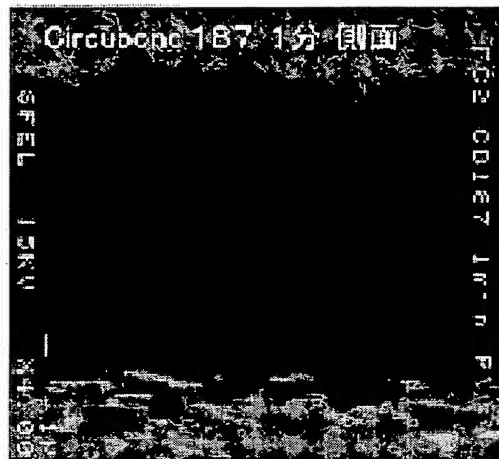
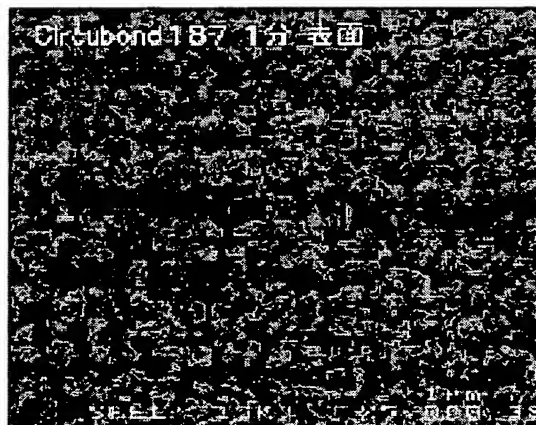


Fig. 4c



Title: METHOD OF FORMING BUMP PAD OF FLIP CHIP
AND STRUCTURE THEREOF

Inventor: TAKAYUKI HAZE

Docket No.: LEPA122745

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9/9

Fig. 4d

